Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("6807064").URPN.	USPAT	OR	ON	2007/03/15 20:11
L2	13	("20020034872"   "5111279"   "5384952"   "5477160"   "5700715"   "5783465"   "5874782"   "5920125"   "5985682"   "6084781"   "6277669"   "6281452"   "6284563").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:33
L3	2	09/925374	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:22
L4	4	("6639315").URPN.	USPAT	OR	ON	2007/03/15 20:22
L5	3	("5148265"   "6049128"   "6130112"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:24
L10	0	jp5144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L11	0	jp50144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L12	0	jp05144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/03/15 20:40
L13	2	de19832706a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:41
S67 2	1	jp2004193456a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35

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S67 3	7	"6441500"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35
S67 4	2	"6339251"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35
S67 5	6	"6495916"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/03/15 14:35
S67 6	15	S673 S674 S675	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:39
S67 7	0	de10105351a1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:39
S67 8	1	de10105351a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:39
S67 9	264	HEDLEND-HARRY-A HEDLER-H HEDLER-HARRY HEDLER-HARRY-DR HEDLER-HARRY-DR-DIPL-PHYS	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2007/03/15 14:43
S68 0	230	S679 and (chip die device electronic semiconductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:44

S68 1	116	S680 and (board leadframe (lead adj frame))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:44
S68 2	18	("20020090761"   "20020140081"   "20030030143"   "20030096518"   "20050070049"   "4748495"   "5400950"   "5781415"   "5796169"   "5908333"   "5947753"   "5981310"   "6012224"   "6130116"   "6238938"   "6562637"   "6717819"   "6848173"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:47
S68 3	0	("6979591").URPN.	USPAT	OR	ON	2007/03/15 14:50
S68 4	18	("20020121706"   "20020130412"   "20030038355"   "20030067755"   "4818728"   "5214308"   "5328087"   "5477087"   "5598033"   "5646828"   "5801446"   "5898223"   "6077723"   "6239983"   "6335571"   "6462420"   "6822317"   "6885106").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:50
S68 5	0	("6919232").URPN.	USPAT	OR	ON	2007/03/15 14:56
S68 6	8	("4927740"   "5212387"   "5998243"   "6043564"   "6177725"   "6429043"   "6448633"   "6507092").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:56

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("6807064").URPN.	USPAT	OR	ON	2007/03/15 20:11
L2	13	("20020034872"   "5111279"   "5384952"   "5477160"   "5700715"   "5783465"   "5874782"   "5920125"   "5985682"   "6084781"   "6277669"   "6281452"   "6284563").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:33
L3	2	09/925374	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:22
L4	. 4	("6639315").URPN.	USPAT	OR	ON	2007/03/15 20:22
L5	3	("5148265"   "6049128"   "6130112"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:24
L10	0	jp5144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L11	0	jp50144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L12	0	jp05144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L13	2	de19832706a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/03/15 20:41
L14	3130	257/e23.021.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:01

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L15	2570	257/e23.124.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/03/15 21:01
L16	5618	14 15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:01
L17	391	16 and elastomer\$2 and (electronic wafer chip die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:03
L18	357	17 and (etch\$3 remove\$1 removing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:03
L19	100	18 and ((contact electrode connection) with protrud\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:04
L20	107	18 and ((contact terminal electrode connection) with protrud\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:04
L21	0	("6927489").URPN.	USPAT	OR	ON	2007/03/15 21:13
L22	1	("6051450").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 21:13